

1. Features

- Typical 1dB bandwidth of 18.5 MHz
- High attenuation
- Single Ended Operation
- Dual In-line Package (DIP)

RoHS Compliant

Tested by SGS Testing Korea

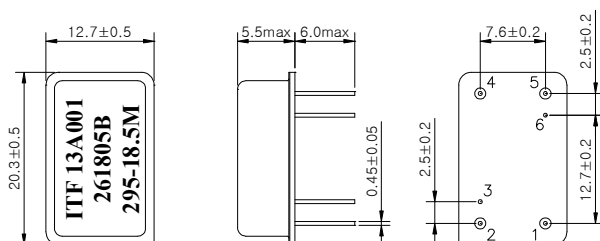
2. Electrical Specifications

Source and Load Impedance = 50Ω

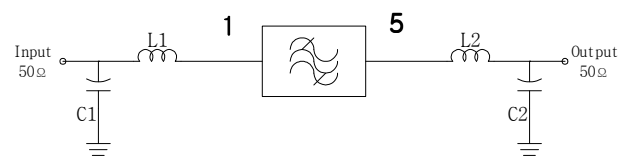
Room Temperature : +25°C		Minimum	Typical	Maximum
Center Frequency (fo)	MHz	-	295.0	-
Insertion Loss	dB	-	27.5	29.0
1dB Bandwidth	MHz	18.40	18.55	-
3dB Bandwidth	MHz	-	19.05	-
45dB Bandwidth	MHz	-	20.83	20.90
Amplitude Ripple (Fo±9.0075MHz)	dB	-	0.5	1.2
Group Delay Variation (Fo±9.0075MHz)	nsec	-	40	80
Absolute Delay	usec	-	2.23	2.25
Ultimate Rejection	dB	47	53	-
Temperature Coefficient of Frequency	ppm/°C	-	-18	-
Substrate Material	-		112-LT	

Input Power : +10dBm

D2012 Package Dimension



Matching Schematic



$$L1 = L2 = 6.8\text{nH}, C1 = C2 = 24\text{pF}$$

Dimensions shown are nominal in millimeters

Base : Fe(SPCC), Au plating over Ni plated
 Cap : Cu & Cr Alloy, Ni Plated
 Termination : Kovar, Au Plated

Pin Configuration

Input	1	Ground	2,4
Output	5	Others	Ground

3. Typical Performance (at +25°C)

